



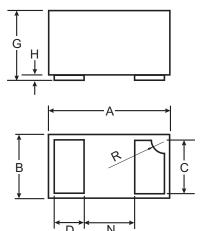
## SURFACE MOUNT FAST SWITCHING DIODE

#### **Features**

- Fast Switching Speed
- Ultra-Small Surface Mount Package
- For General Purpose Switching Applications
- High Conductance
- Lead Free by Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

#### **Mechanical Data**

- Case: DFN1006-2
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminal Connections: Cathode Dot
- Terminals: Finish NiPdAu annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Marking Code: T8, Dot Denotes Cathode Side
- Ordering Information: See Last Page
- Weight: 0.001 grams



DFN1006-2				
Dim	Min	Max	Тур	
Α	0.95	1.075	1.00	
В	0.55	0.675	0.60	
С	0.45	0.55	0.50	
D	0.20	0.30	0.25	
G	0.47	0.53	0.50	
Н	0	0.05	0.03	
N	N		0.40	
R	<b>R</b> 0.05 0		0.10	
All Dimensions in mm				

### Maximum Ratings @ T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage	V <sub>RM</sub>	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>R</sub> WM V <sub>R</sub>	80	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	57	V
Forward Continuous Current	I <sub>FM</sub>	250	mA
Average Rectified Output Current	Io	125	mA
Non-Repetitive Peak Forward Surge Current @ t = 1.0μs @ t = 1.0s	I <sub>FSM</sub>	2.0 1.0	A
Operating and Storage Temperature Range	T <sub>j</sub> , T <sub>STG</sub>	-65 to +150	°C

### Thermal Characteristics @ TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Power Dissipation	Pd	250	mW
Thermal Resistance Junction to Ambient	$R_{ hetaJA}$	500	°C/W

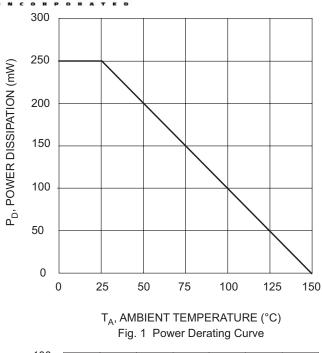
### **Electrical Characteristics** @ T<sub>A</sub> = 25°C unless otherwise specified

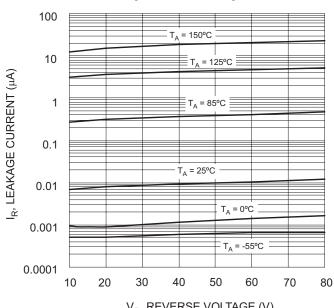
Characteristic	Symbol	Min	Max	Unit	Test Conditions
Reverse Breakdown Voltage (Note 3)	V <sub>(BR)R</sub>	80	_	٧	I <sub>R</sub> = 100μA
Forward Voltage (Note 3)	V <sub>F</sub>	0.62 — — —	0.72 0.855 1.0 1.25	V	I <sub>F</sub> = 5.0mA I <sub>F</sub> = 10mA I <sub>F</sub> = 100mA I <sub>F</sub> = 150mA
Peak Reverse Current (Note 3)	I <sub>R</sub>	_	100 50 30 25	nA μA μA nA	$V_R = 80V$ $V_R = 75V$ , $T_j = 150^{\circ}C$ $V_R = 25V$ , $T_j = 150^{\circ}C$ $V_R = 20V$
Total Capacitance	Ст	_	3.0	pF	V <sub>R</sub> = 0.5V, f = 1.0MHz
Reverse Recovery Time	t <sub>rr</sub>	_	4.0	ns	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \text{ x } I_R, R_L = 100 \Omega$

Note: 1. No purposefully added lead.

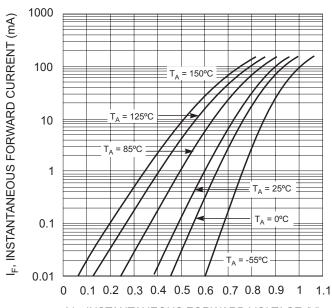
- 2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead\_free/index.php.
- 3. Short duration pulse test used so as to minimize self-heating effect.



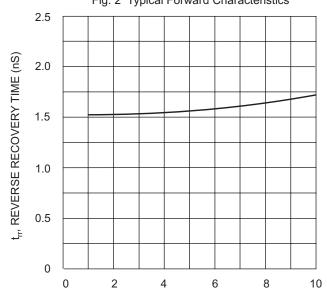




 $V_R$ , REVERSE VOLTAGE (V) Fig. 3 Typical Reverse Characteristics



V<sub>F</sub>, INSTANTANEOUS FORWARD VOLTAGE (V) Fig. 2 Typical Forward Characteristics



I<sub>F</sub>, FORWARD CURRENT (mA) Fig. 4 Reverse Recovery Time vs. Forward Current

### Ordering Information (Note 4)

Device	Packaging	Shipping
1N4448HLP-7	DFN1006-2	3000/Tape & Reel

Note: 4. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

# **Marking Information**

• T8

T8 = Product Type Marking Code, Dot Denotes Cathode Side



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